

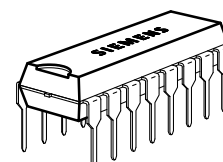
256 x 8-Bit Static CMOS RAM NMOS-Compatible

SAE 81C52

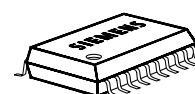
Preliminary Data CMOS IC

Features

- 256 x 8-bit organization
- Standby mode
- Compatible with the NMOS and CMOS versions of the microprocessor/microcontroller families SAB 8086, SAB 8051
- Very low power dissipation
- Data retention up to $V_{DD} \geq 1\text{ V}$
- Three different chip select inputs for two chip select modes
- No increasing power consumption in standby mode if the control inputs are on undefined potential
- Temperature range – 40 to 110 °C



P-DIP-16-1



P-DSO-20-1

Type	Ordering Code	Package
SAE 81C52 P	Q67100-H9017	P-DIP-16-1
SAE 81C52 G	Q67100-H9015	P-DSO-20-1 (SMD)

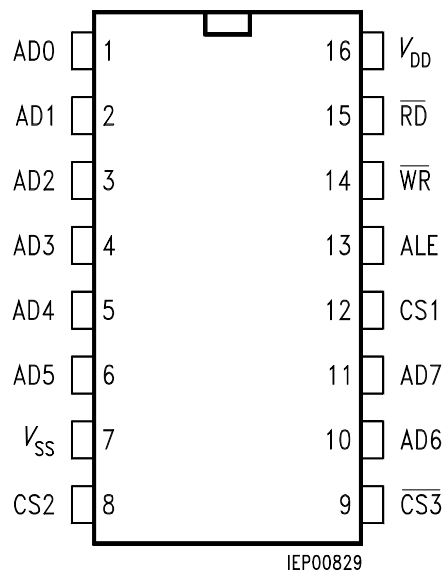
The SAE 81C52 is a CMOS-silicon gate, static random access memory (RAM), organized as 256 words by 8 bits. The multiplexed address and data bus interfaces directly to 8-bit microprocessors/microcontrollers without any timing or level problems, e.g. the families SAB 8086, SAB 8051.

All inputs and outputs are fully compatible with NMOS circuits, except CS1. Data retention is ensured up to $V_{DD} \geq 1.0\text{ V}$. The SAE 81C52 has three different inputs for two chip select modes which allow to inhibit either the address/data lines ($\overline{AD\ 0 \dots AD\ 7}$) and the control lines ($\overline{WR}$, $\overline{RD}$, $\overline{ALE}$, CS2, CS3), or only the control lines $\overline{RD}$, $\overline{WR}$.

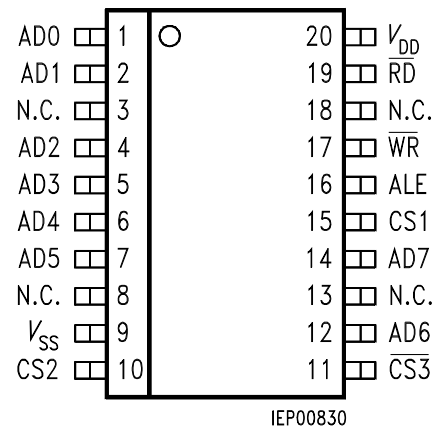
The power consumption is max. 5.5 μW in standby mode and max. 16.5 mW in operation. In standby mode, the power consumption will not increase if the control inputs are on undefined potential.

Pin Configurations (top view)

SAE 81C52 P

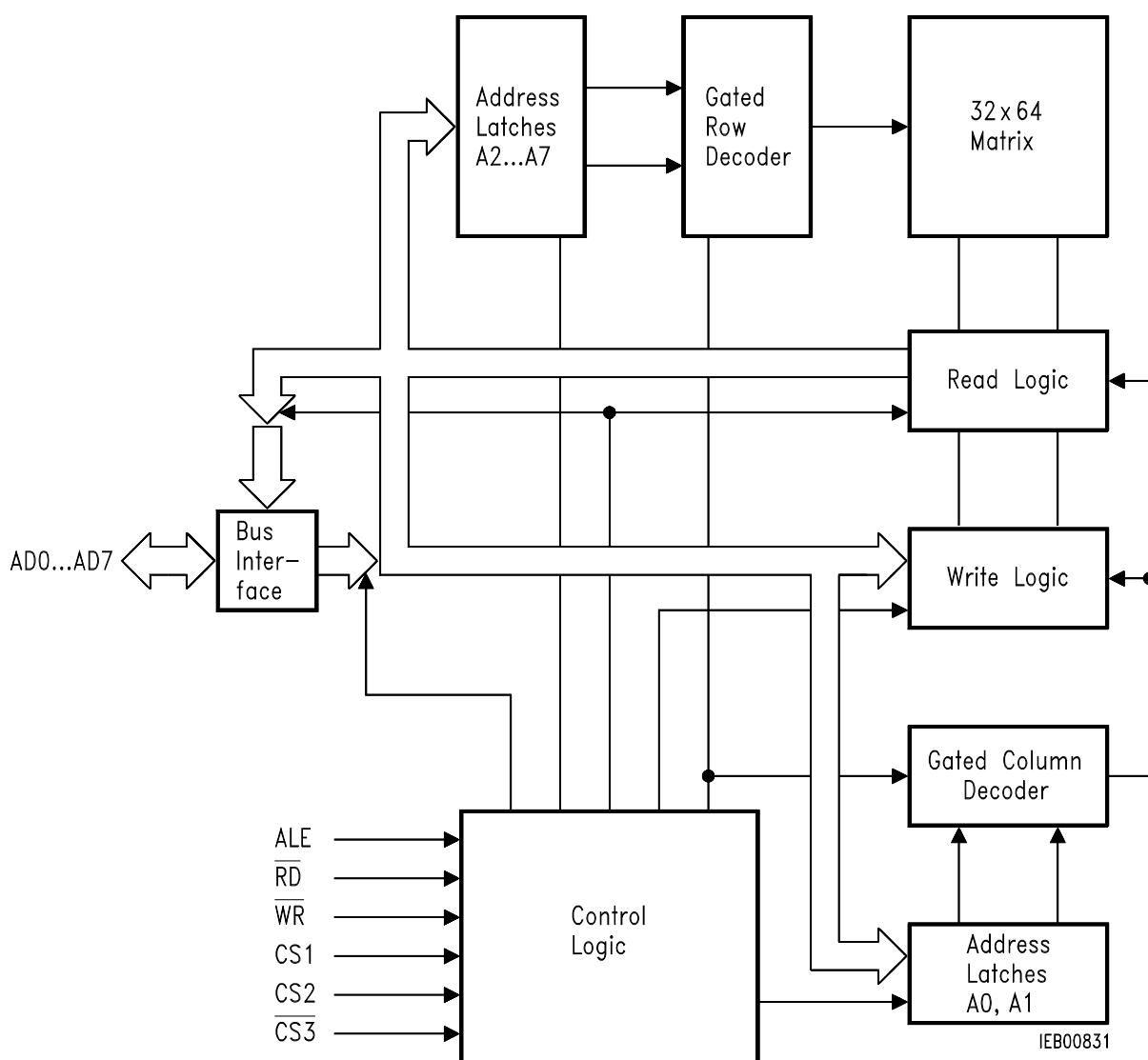


SAE 81C52 G

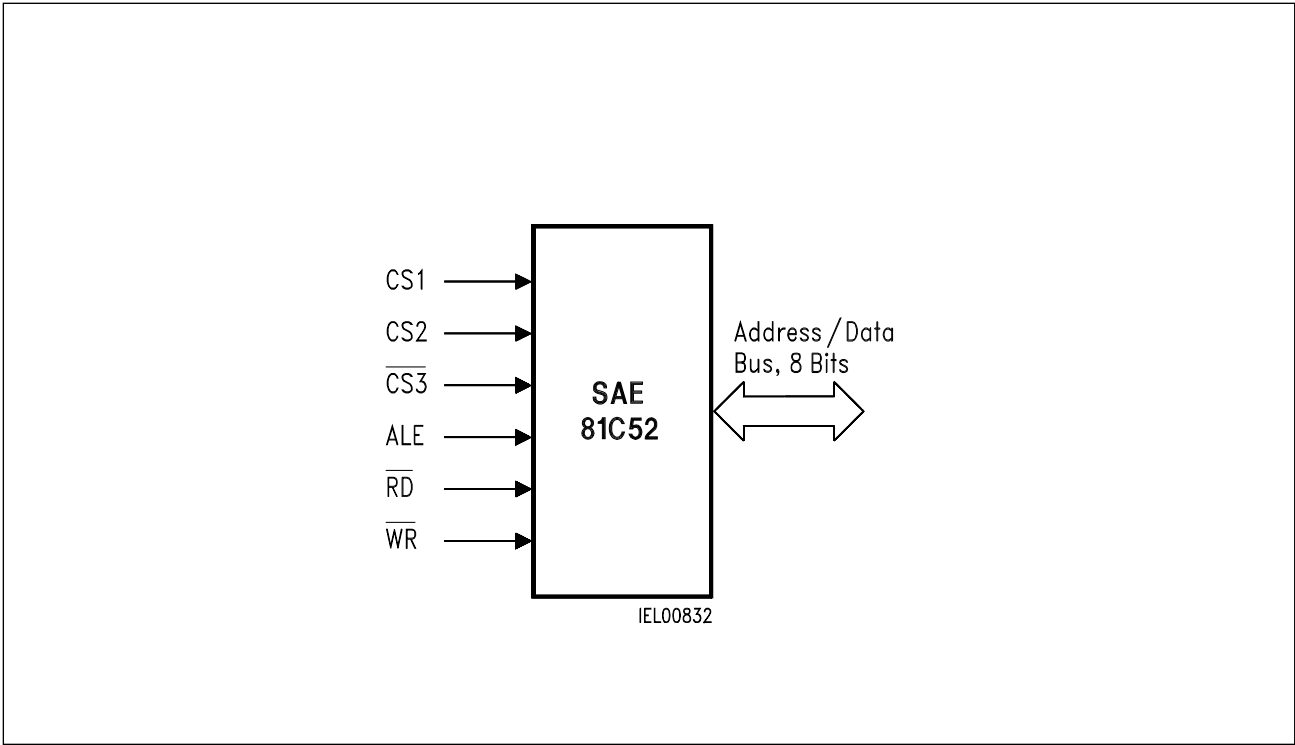


Pin Definitions and Functions

SAE 81C52 G	SAE 81C52 P	Symbol	Function
Pin No.	Pin No.		
1, 2, 4, 5, 6 7, 12, 14	1 ... 6 10, 11	AD0 ... 7	Address/data lines
15	12	CS1	Chip select 1 (standby) active low; inhibits all lines including control lines
16	13	ALE	Address latch enable
17 19	14 15	$\overline{WR}$ $\overline{RD}$	Write enable Read enable
20	16	V_{DD}	Power supply
9	7	V_{SS}	GND (0 V)
10 11	8 9	CS2 $\overline{CS3}$	Chip select 2; inhibits control inputs $\overline{RD}$, $\overline{WR}$ Counterpart to CS2



Block Diagram



Logic Symbol

Truth Table

CS1	CS2	CS3	ALE	RD	WR	AD0 ... AD7	Function
L	*	*	*	*	*	Floating (tristate)	Standby
H	X	X	H	H	H	Addresses to memory	Store addresses
H	H	L	L	L	H	Data from memory	Read
H	H	L	L	H	L	Data to memory	Write
H	L	X	L	X	X	Floating (tristate)	None
H	X	H	L	X	X	Floating (tristate)	None

*: Level = $V_{SS} \dots V_{DD}$
X: Level = low or high

Absolute Maximum Ratings

$T_A = -40$ to $110\text{ }^{\circ}\text{C}$

Parameter	Symbol	Limit Values	Unit
Supply voltage referred to GND (V_{SS}) All input and output voltages	V_{DD} V_{IM}	0 to 6 $V_{SS} - 0.3$ $V_{DD} + 0.3$	V V V
Total power dissipation Power dissipation for each output	P_{tot} P_Q	250 50	mW mW
Junction temperature Storage temperature	T_j T_{stg}	125 – 55 to 125	$^{\circ}\text{C}$ $^{\circ}\text{C}$
Thermal resistance system - air P-DIP-16-1 P-DSO-20-1	$R_{th\ SA}$ $R_{th\ SA}$	70 95	K/W K/W

Operating Range

Supply voltage	V_{DD}	4.5 to 5.5	V
Ambient temperature	T_A	– 40 to 110	$^{\circ}\text{C}$

DC Characteristics

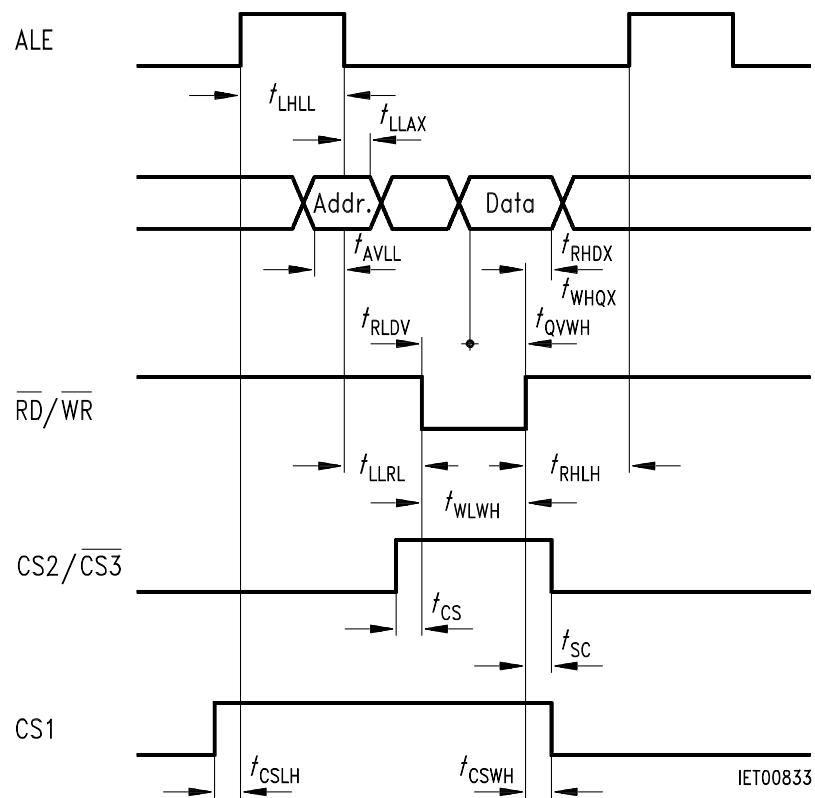
$T_A = -40$ to 110 °C; $V_{DD} = 4.25$ V to 5.5 V; $V_{SS} = 0$ V

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Standby supply current	I_{DD}		1	μA	$V_{DD} = 5.5$ V; $T_A = 25$ °C; $V_{CS1} = 0$ V $\Delta t_{cyc} = 1$ μs; $V_{DD} = 5.5$ V; $C_L = 100$ pF
Supply current	I_{DD}		3	mA	
Standby voltage for data retention	V_{DD}	1.0		V	
L-input current (for each input)	I_{IL}		1	μA	$V_I = 0$ to V_{DD}
Output leakage current	I_{QLK}		1	μA	$V_Q = 0$ to V_{DD} tristate
L-input voltage	V_{IL}	V_{SS}	0.8	V	
H-input voltage	V_{IH}	2.2	V_{DD}	V	
L-output voltage	V_{QL}		0.4	V	$I_{QL} = 1$ mA
H-output voltage	V_{QH}	2.6		V	$I_{QL} = 1$ mA
L-input voltage CS1	V_{IL}	V_{SS}	1	V	
H-input voltage CS1	V_{IH}	$V_{DD} - 1$	V_{DD}	V	

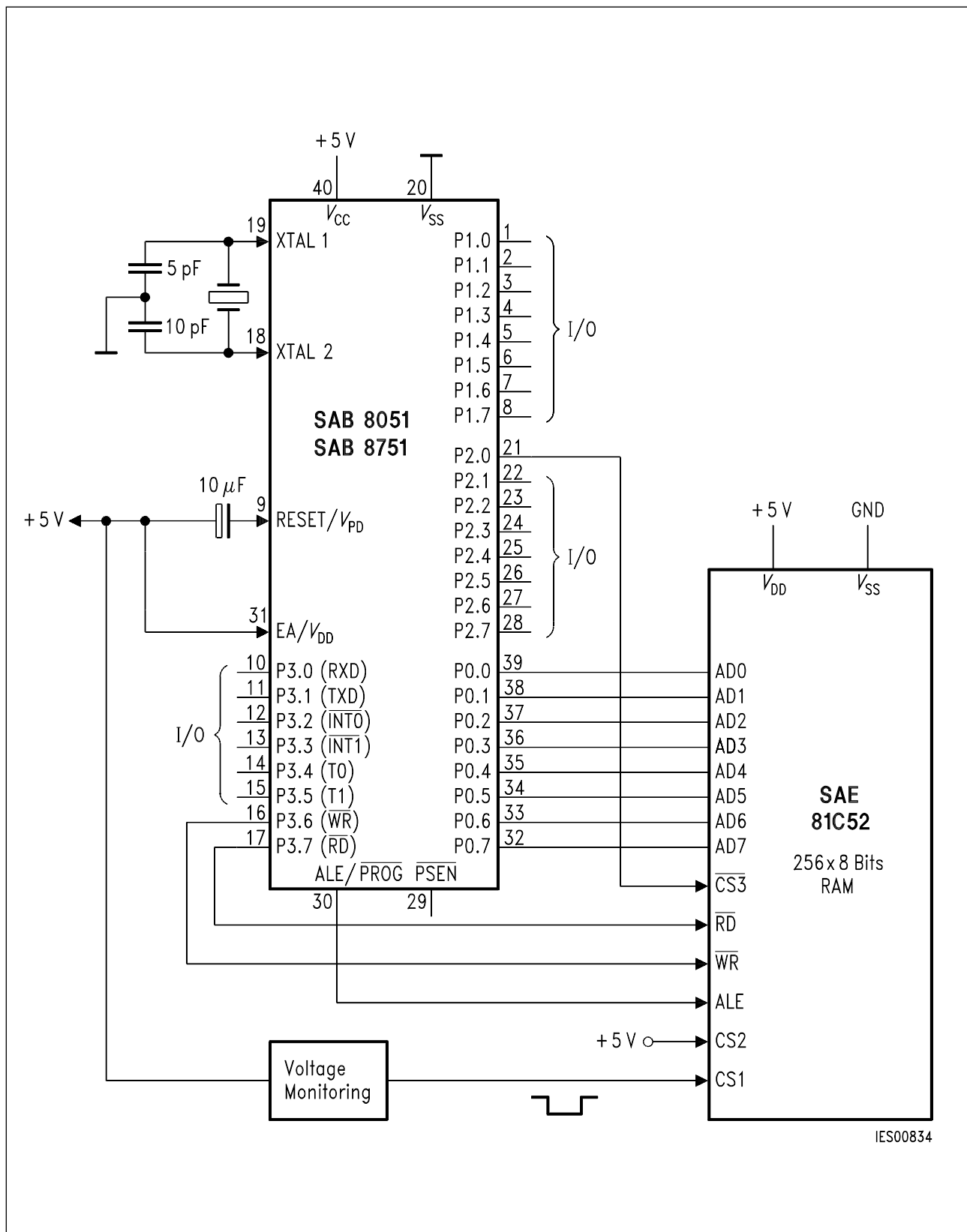
AC Characteristics

$T_A = -40$ to $110\text{ }^{\circ}\text{C}$; $V_{DD} = 4.5$ to 5.5 V ; $V_{SS} = 0\text{ V}$

Parameter	Symbol	Limit Values		Unit
		min.	max.	
ALE pulse width	t_{LHLL}	100		ns
ALE low before $\overline{\text{RD}}$ low	t_{LLRL}	50		ns
$\overline{\text{RD}}$ high before ALE high	t_{RHLH}	18		ns
ALE low before $\overline{\text{WR}}$ low	t_{LLWL}	50		ns
$\overline{\text{WR}}$ high before ALE high	t_{WHLH}	18		ns
Address setup before ALE	t_{AVLL}	18		ns
Address hold after ALE	t_{LLAX}	30		ns
$\overline{\text{WR}}$ or $\overline{\text{RD}}$ pulse width	t_{WLWH}	250		ns
Data setup before $\overline{\text{WR}}$	t_{QVWH}	50		ns
Data hold after $\overline{\text{WR}}$	t_{WHQX}	18		ns
Data hold after $\overline{\text{RD}}$	t_{RHDx}		90	ns
Chip select (2, 3) before $\overline{\text{RD}}$, $\overline{\text{WR}}$	t_{CS}	50		ns
Chip select (2, 3) after $\overline{\text{RD}}$, $\overline{\text{WR}}$	t_{SC}	18		ns
Chip select 1 before ALE	t_{CSLH}	20		ns
Chip select 1 after $\overline{\text{RD}}$, $\overline{\text{WR}}$	t_{CSWH}	50		ns
Output delay time	t_{RLDV}		200	ns
Input capacitance to V_{SS} (for each input)	C_i		10	pF



Timing Diagram



IES00834

Application Circuit

SAE 81C52 with the μC SAB 8051